



EPSTEIN & GERKEN
1901 Research Boulevard
Suite 340
Rockville, Maryland 20850-3164
(301) 610-7634

1742
HF 12823
61
C.C.
RECEIVED
JUL 06 2004
TECH CENTER 2800

In re the PATENT application of

T.L. Ritzdorf et al

Examiner: Leader

Serial No.: 09/880,715

Group Art Unit: 2823

Filed: June 12, 2001

For: Method for Filling Recessed Micro-Structures with Metallizations in the Production of a Microelectronic Device

MAIL STOP: AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith are the following documents for filing in the subject patent application:

Petition for Extension of Time;

Credit Authorization Form PTO-2038 in the amount of \$950.00 for payment of the Extension of Time fee;

Notice of Appeal from the Primary Examiner to the Board of Patent Appeals and Interferences; and

Credit Authorization Form PTO-2038 in the amount of \$330.00 for payment of Notice of Appeal fee.

Respectfully submitted,

Robert H. Epstein
Registration No. 24,353

Hand Delivered: 6-30-04